



PC20N04

Product Specification

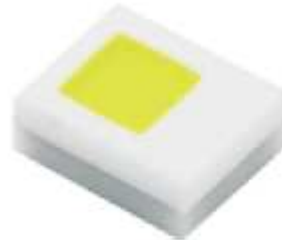
Approval Sheet

PC20N04

Product Specification

RoHS

| | |
|--------------------|----------------|
| Product | 2016 White LED |
| Part Number | PC20N04 |
| Issue Date | 2017/12/11 |



■ Feature

- ✓ White SMD LED (L x W x H) of 2.09 x 1.68 x 0.75 mm
- ✓ AEC-Q101 D and IEC 60810 qualification
- ✓ Dice Technology : InGaN
- ✓ Qualified according to JEDEC moisture sensitivity Level 1
- ✓ Environmental friendly ; RoHS compliance
- ✓ Packing : 500/1000/2000 pcs/reel

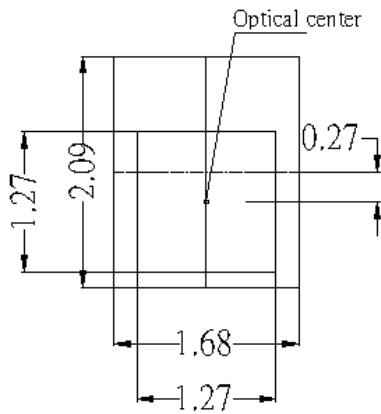
■ Applications

- ✓ DRL
- ✓ Fog light
- ✓ Head lamp

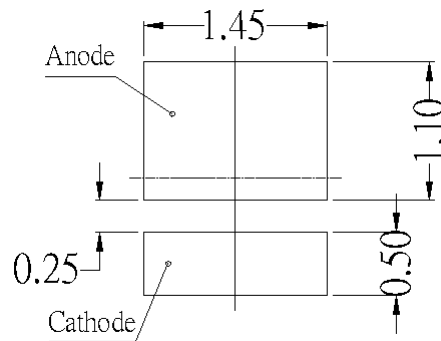
tion

■ **PKG Size:**

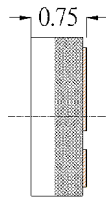
2.09 mm * 1.68 mm * 0.75 mm (L X W X H)



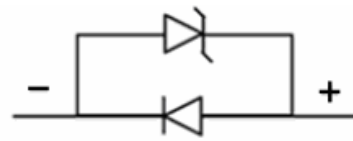
Top view



Bottom view

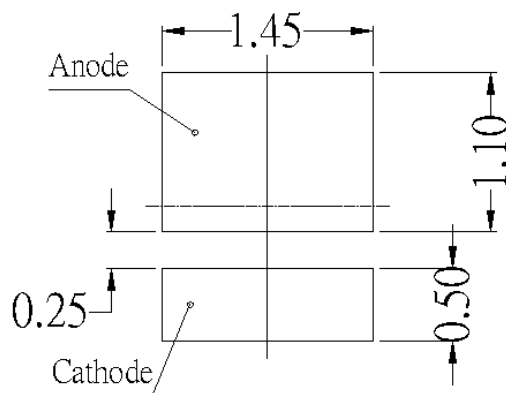


Side view



Equivalent Circuit

■ **Recommend Soldering Pad Layout**



Unit: mm, Tolerance: ± 0.10 mm

Performance

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■ Electro-Optical Characteristics (Ta=25°C)

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit |
|--------------------------------|----------------------|--------------------------|------|------|------|------|
| Forward Voltage ⁽¹⁾ | V _F | I _F = 1000 mA | 2.9 | 3.3 | 3.7 | V |
| Luminous Flux | Φ _V | | 220 | 300 | 360 | Lm |
| View Angle | θ | | 110 | 120 | 130 | deg |
| Electrical Thermal Resistance | R _{th,elec} | | -- | 4 | -- | °C/W |

(1) The Forward Voltage tolerance is ±0.05V

(2) The luminous flux tolerance is ±8%

(3) Thermal resistance is calculated from junction to solder

(4) Electric and optical data is tested at 50 ms pulse condition

(5) The Chromaticity Coordinates tolerance is x,y: ±0.005

■ Absolute Maximum Ratings

| Parameter | Symbol | Value | Unit |
|--------------------------------------|-----------------------|------------------|------|
| DC Forward Current ⁽¹⁾ | I _F | 1200 | mA |
| Power Dissipation | P _D | 3.96 | W |
| Pulse Forward Current ⁽²⁾ | I _{FP} | 1500 | mA |
| Storage Temperature | T _{stg} | -40 ~ +125 | °C |
| Operating Temperature | T _{opr} | -40 ~ +125 | °C |
| Junction Temperature | T _J | 150 | °C |
| Assembly Temperature | T _{sld} | 260 (max. 30sec) | °C |
| ESD withstand voltage | V _{ESD(HBM)} | 8 | kV |

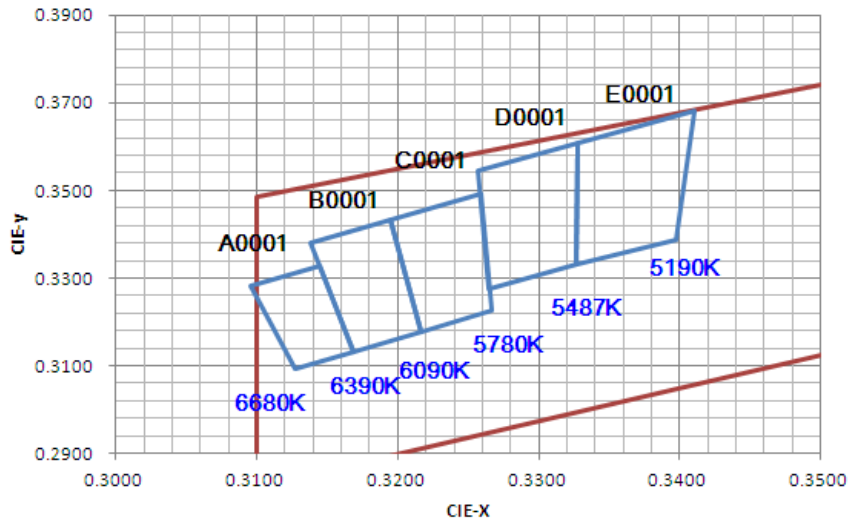
(1) Proper current rating must be observed to maintain junction temperature below maximum at all time

(2) IFP shall be applied under condition as max duration time 400ms and 1/10 duty cycle.

Binning

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Chromaticity Coordinates



Bin code definition

| V _F Rank | Luminous Flux Rank | CIE Rank |
|---------------------|--------------------|----------|
| A | U3 | A0001 |

| V _F Rank | Condition | Voltage | |
|---------------------|-------------------------------------|---------|------|
| | | Min. | Max. |
| A | I _F = 1000 mA Ta=25°C | 2.8 | 3.1 |
| B | | 3.1 | 3.4 |
| C | | 3.4 | 3.7 |

* The Forward Voltage tolerance is ±0.05V

| Luminous Flux Rank | Condition | Luminance Flux(Lm) | |
|--------------------|-----------------------------------|--------------------|------|
| | | Min. | Max. |
| U2 | I _F =1000mA Ta=25°C | 240 | 260 |
| U3 | | 260 | 280 |
| U4 | | 280 | 300 |
| U5 | | 300 | 320 |
| U6 | | 320 | 340 |
| U7 | | 340 | 360 |

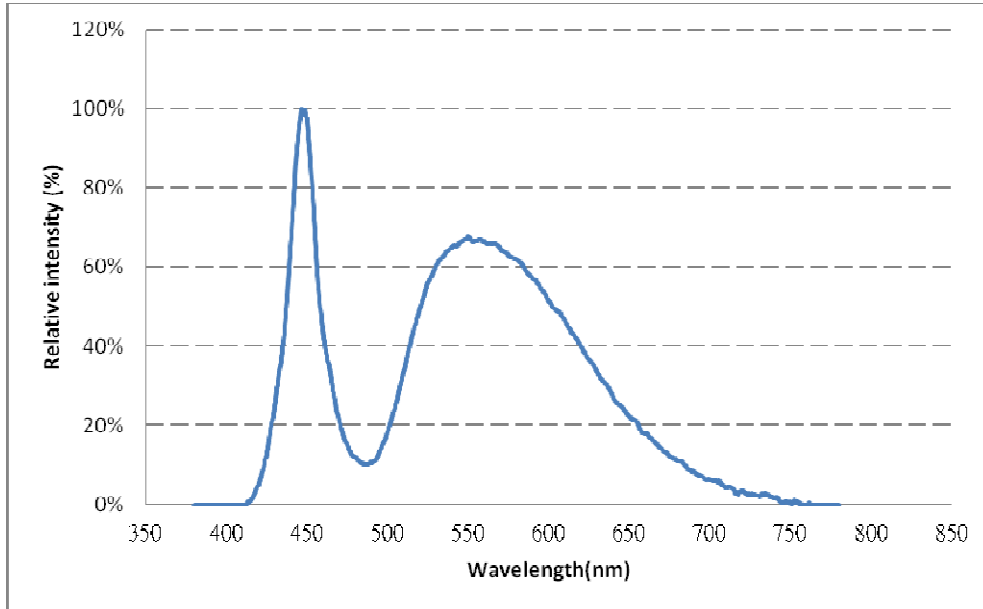
* The luminous intensity tolerance is ± 8%

■ **CIE Rank**

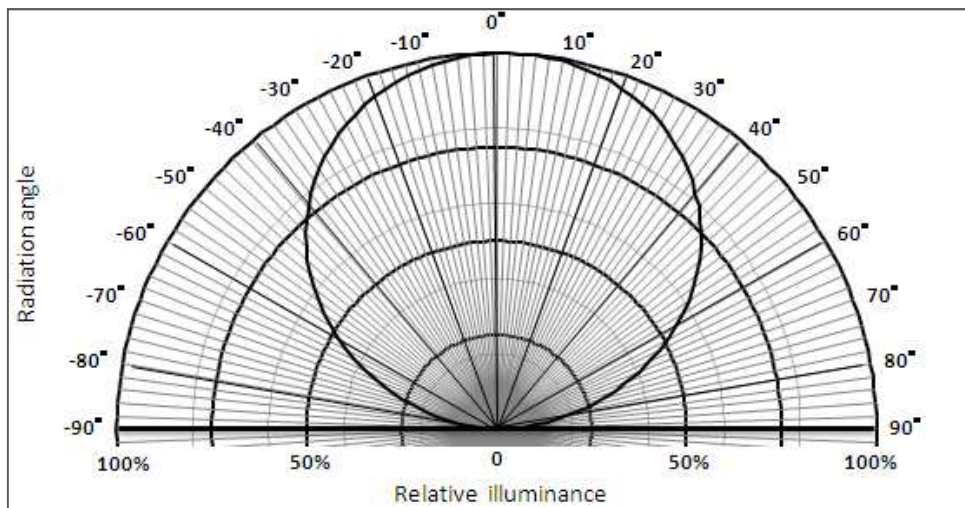
| CCT | CIE Rank | CIE X | CIE Y |
|--------------------|-----------------|--------------|--------------|
| 6385 ~ 6680 | A0001 | 0.3096 | 0.3283 |
| | | 0.3145 | 0.3328 |
| | | 0.3169 | 0.3133 |
| | | 0.3127 | 0.3093 |
| 6080 ~ 6385 | B0001 | 0.3138 | 0.3381 |
| | | 0.3195 | 0.3433 |
| | | 0.3216 | 0.3178 |
| | | 0.3169 | 0.3133 |
| 5780 ~ 6080 | C0001 | 0.3195 | 0.3433 |
| | | 0.3259 | 0.3491 |
| | | 0.3267 | 0.3228 |
| | | 0.3216 | 0.3178 |
| 5480 ~ 5780 | D0001 | 0.3257 | 0.3546 |
| | | 0.3328 | 0.3608 |
| | | 0.3327 | 0.3331 |
| | | 0.3265 | 0.3276 |
| 5180 ~ 5480 | E0001 | 0.3328 | 0.3608 |
| | | 0.3410 | 0.3681 |
| | | 0.3397 | 0.3387 |
| | | 0.3327 | 0.3331 |
| | | 0.3506 | 0.3765 |
| | | 0.3482 | 0.3510 |
| | | 0.3400 | 0.3443 |

(1) Color bins are tested at IF = 1000mA 50ms pulse operation condition

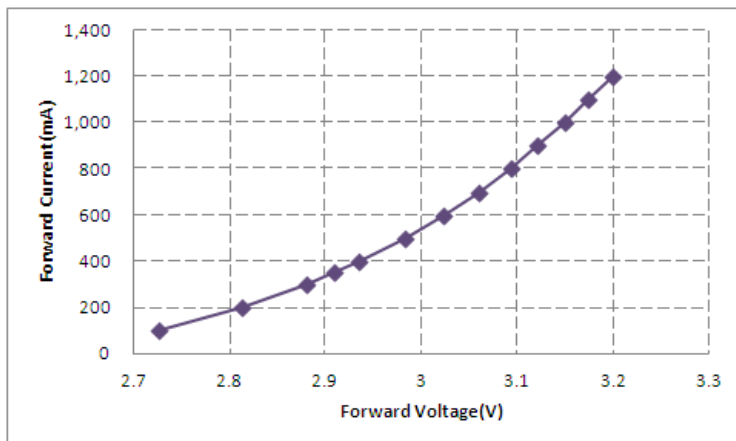
■ Spectrum



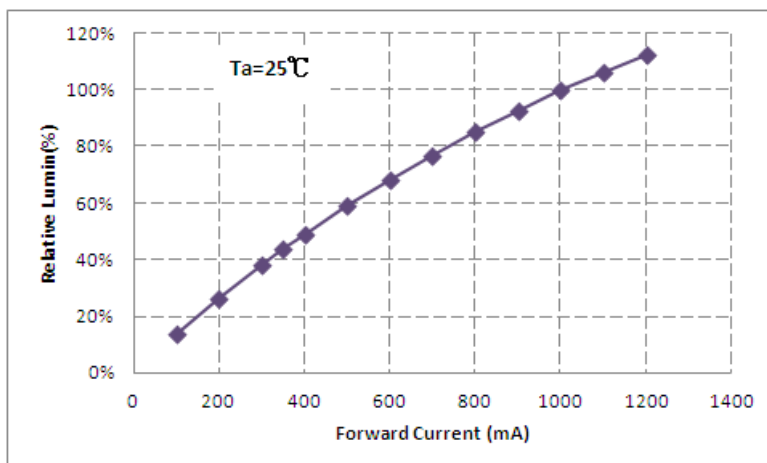
■ Radiation Pattern



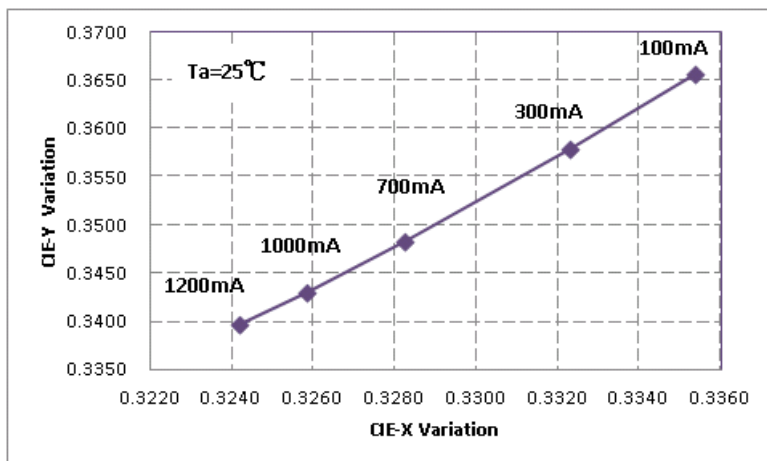
■ Forward Voltage vs. Forward Current



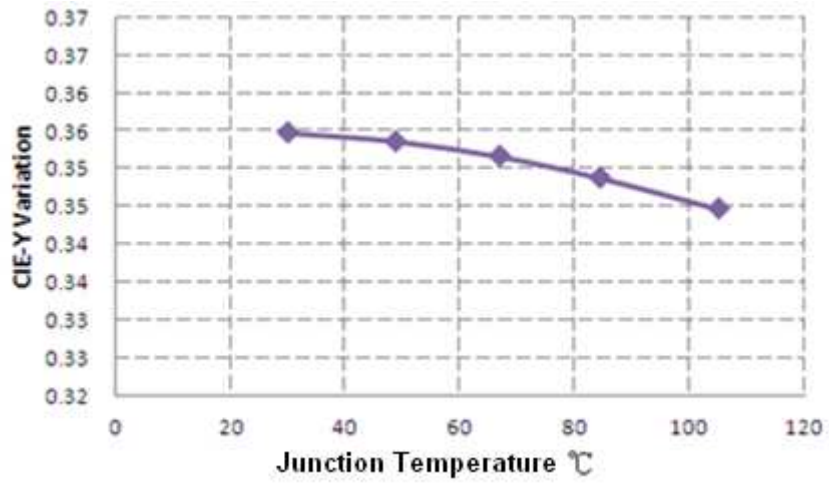
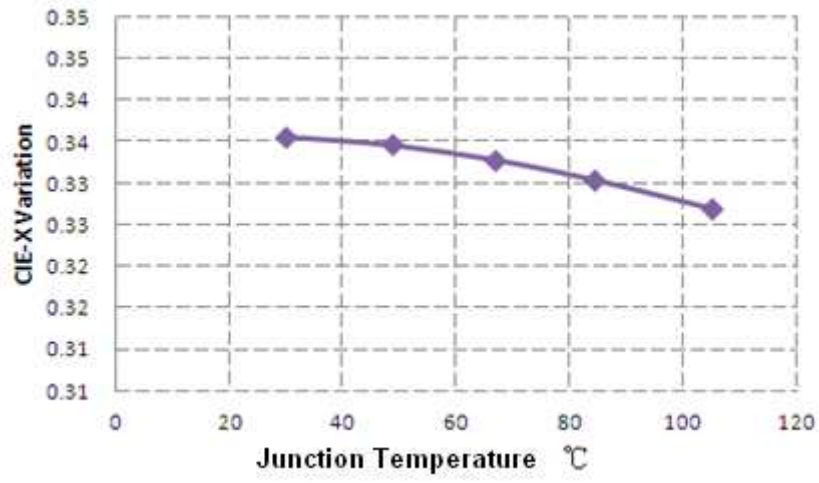
■ Forward Current vs. Relative Luminosity



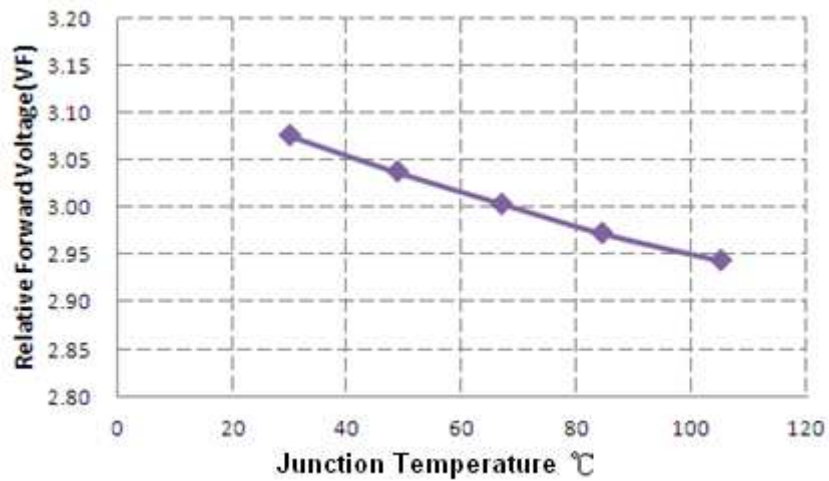
■ Forward Current vs. Chromaticity Coordinate



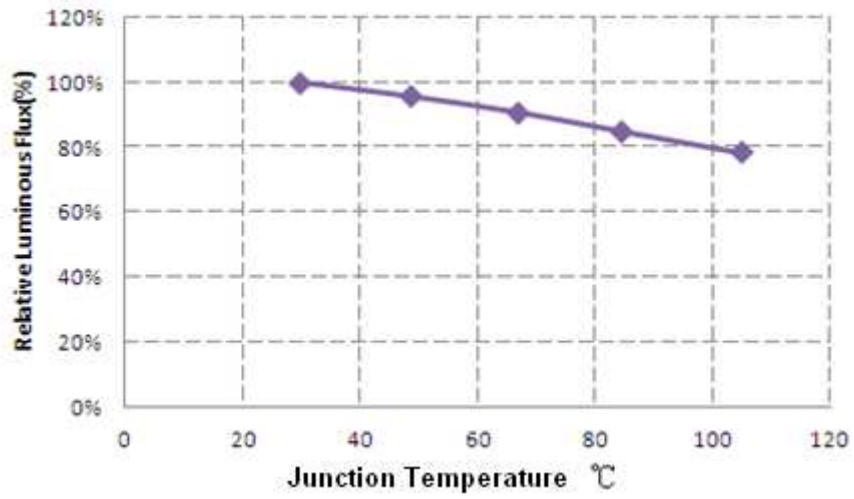
■ Chromaticity Coordinate vs. Junction Temperature



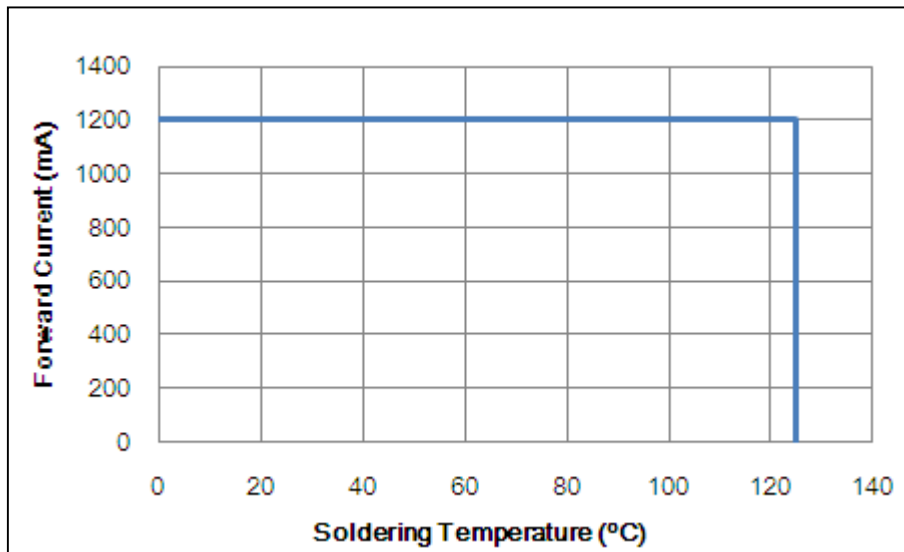
■ Relative Forward Voltage vs. Junction Temperature



■ Relative Luminous Intensity vs. Junction Temperature



■ Forward Current Derating Curve



Reliability

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Reliability test

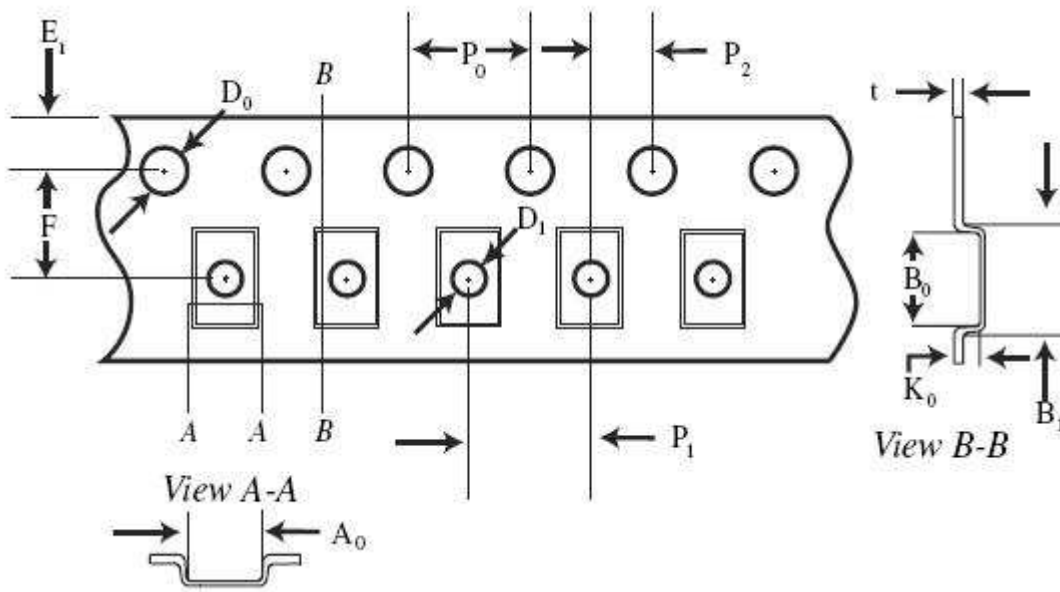
| Item | Reference Standard | Condition | Time/Cycle |
|-------------------------------------|--------------------|--|---------------|
| Thermal shock | JESD22-A106 | -40°C to 100 °C, 20min dwell, 5 min transfer time | 1000Cycles |
| Temperature Cycle | AEC-Q101 Rev. D | -55°C to 125 °C 15 minutes dwell at each high and low temperature extreme | 1000 cycles |
| Power and Temperature Cycle | AEC-Q101 Rev. D | -40 °C~ 85 °C, IF=Max Current, Dwell/transfer time=10mins, 20 mins 1,000 cycles , on/off 15,000 cycles | 15,000 cycles |
| MSL Level 1 | J-STD-020 | 85°C/85% RH | 168 hours |
| High Temperature Storage | JESD22-A103 | TA=105°C, 1000h | 1000hours |
| Low Temperature Storage | JESD22-A119 | TA=-40°C, 1000h | 1000hours |
| High Temperature Operating Life | AEC-Q101 Rev. D | TA=105°C, IF=Max Current | 1000hours |
| Low Temperture Operating Life | JESD22-A108 | TA=-40°C, IF=Max Current | 1000hours |
| Temperature Humidity Operating Life | AEC-Q101 Rev. D | 85°C, RH=85%, 1000h, IF=Max Current | 1000hours |
| Electrostatic Discharges | AEC-Q101 Rev. D | HBM, X KV,1.5KΩ, 100pF, 3pulses, alternately positive or negative | NA |

| Item | Reference Standard | Condition | Time/Cycle |
|----------------------|--------------------|---|------------|
| Corrosion robustness | IEC 60068-2-43 | (H2S) [25°C / 75 % rh / 10 ppm H2S / 21 days] | 336 hrs |
| | IEC 60068-2-60 | [25 °C / 75 % rh / 200 ppb SO2, 200 ppb NO2,10 ppb Cl2 / 21 days] | 504 hrs |

■ **Judgment Criteria**

| Item | Symbol | Test Condition | Judgment Criteria |
|-----------------|--------------|----------------|---------------------|
| Forward Voltage | Vf | 1000mA | $\Delta Vf < 10\%$ |
| Luminous Flux | Iv | 1000mA | $\Delta Iv < 20\%$ |
| Delta CIE | CIE-x ,CIE-y | 1000mA | $\Delta x,y < 0.01$ |

■ **Emitter Pocket Tape Packing**



Unit : mm

| Item | Spec | Tol(+/-) | Item | Spec | Tol(+/-) |
|-------|------|------------|---------|-------|------------|
| W | 8.00 | ± 0.20 | P2 | 2.00 | ± 0.05 |
| E | 1.75 | ± 0.10 | P0 x 10 | 40.00 | ± 0.10 |
| F | 3.50 | ± 0.05 | T | 0.23 | ± 0.05 |
| D0 | 1.50 | ± 0.1 | A0 | 1.90 | ± 0.10 |
| D1 | 1.50 | ± 0.25 | B0 | 2.30 | ± 0.10 |
| P0 P1 | 4.00 | ± 0.10 | K0 | 0.85 | ± 0.10 |

Packing

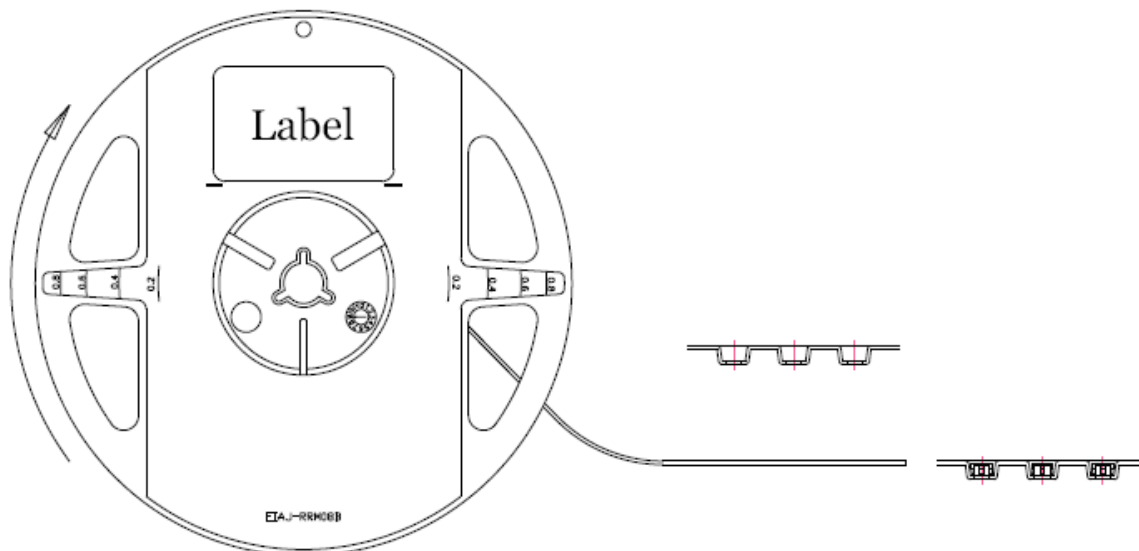
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Label



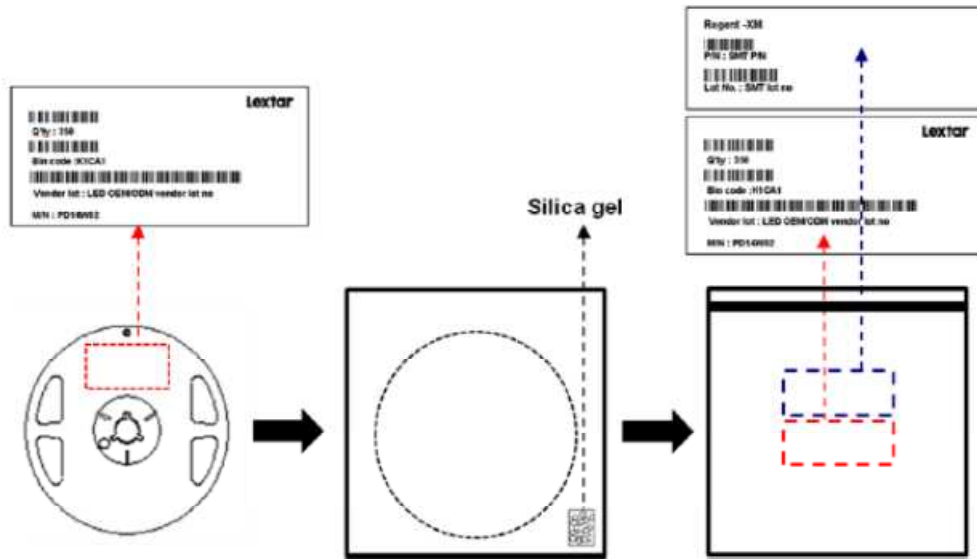
Carrier Taping



Notice:

1. 10 Sprocket hole pitch cumulative tolerance is $\pm 0.20\text{mm}$.
2. Carrier camber shall be not more than 1mm per 100mm through a length of 250mm.
3. Ao & Bo measured on a place in the middle of the corner radii.
4. Ko measured from a place on the inside bottom of the pocket to top surface of carrier.
5. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.
6. Surface resistivity $10^4 \sim 10^8$ ohm/sq.

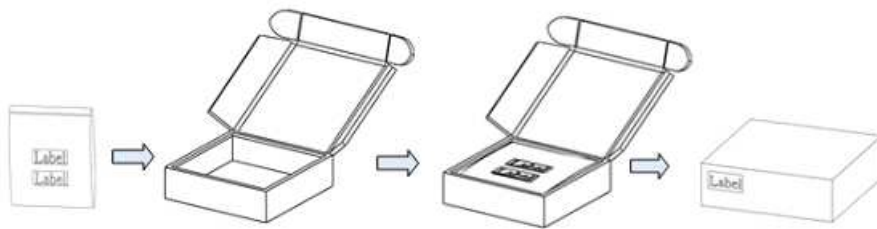
Shield Bag Taping



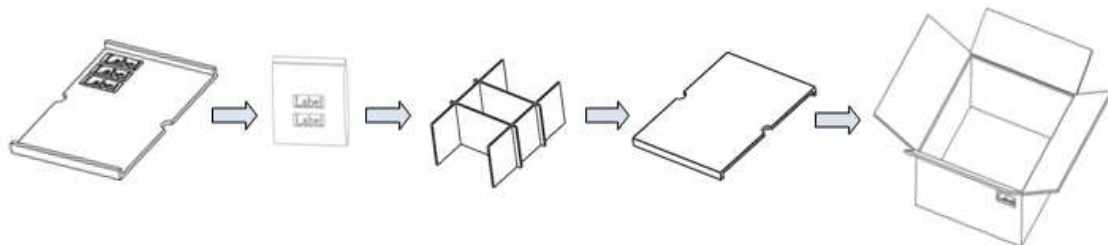
Packing Box

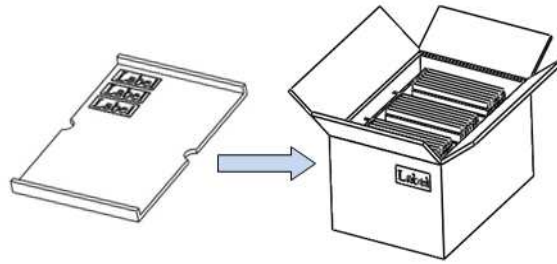
| Type | Large Box | | Medium Box | | Small Box | |
|---------------|---------------|------|---------------|------|--------------|-----|
| Dimension | 541X511X276mm | | 385X303X260mm | | 283X235x70mm | |
| Maximum Reels | 7"X12mm Reel | 64/R | 7"X12mm Reel | 21/R | 7"X12mm Reel | 4/R |
| Minimum Reels | 7"X12mm Reel | 32/R | 7"X12mm Reel | 9/R | 7"X12mm Reel | 1/R |

Small Box

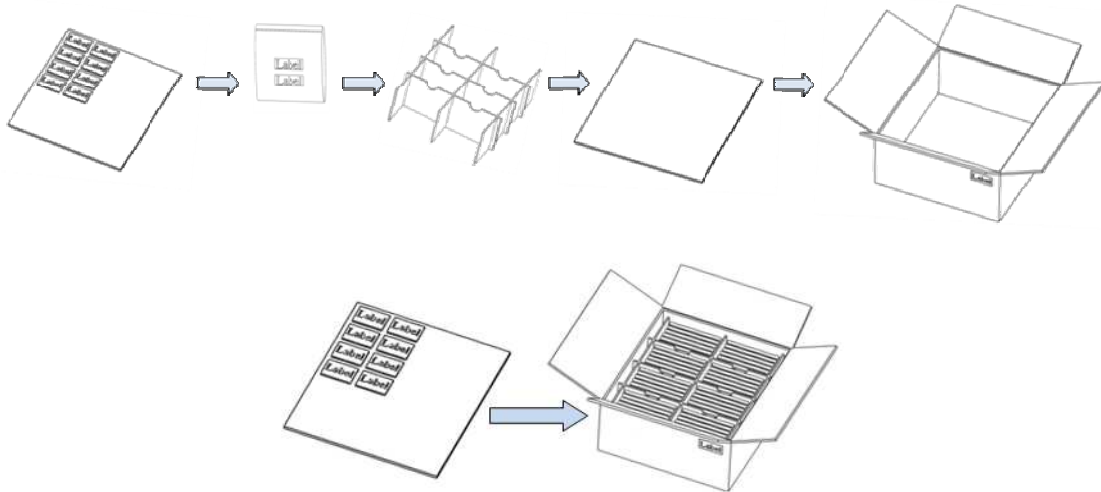


Medium Box





■ Large Box



Precautions

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■ Safety Precautions

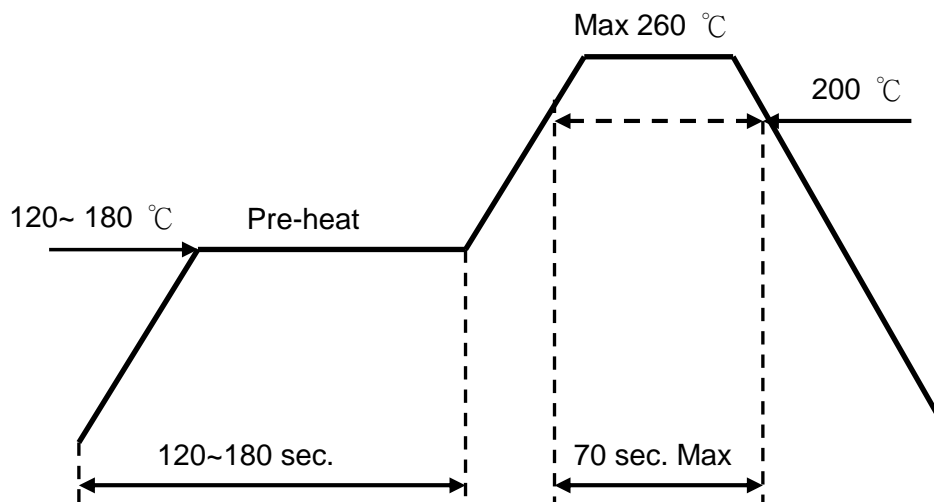
- The LED light output is too strong for human eyes without shield. Prevent eye contact directly more than seconds.
- Ensure operating under maximum rating.

■ Storage

- Before opening the package, the LEDs should storage under 30°C, 60% RH.
- After opening the package bag, the LEDs should be keep under 30°C, 60% RH. Recommend to use within 168 hrs. If unused LEDs remain, suggest to store into moisture proof bag or original package bag with moisture absorbent material such as silica gel. Reseal well is necessary.
- If the product exceeded the storage period or the moisture absorbent material faded away, baking treatment should be done by following conditions.
Bake condition: 60°C, 12hours (One time only).

■ Soldering Notice and Conditions

- When soldering LEDs,
- Do not solder/reflow the same LED over two times.
- Recommend soldering conditions:
Hand soldering: 350 °C max, 3 sec. max.
Reflow soldering: Pre-heat 150 °C max, 180 sec. max.
Peak 260 °C max, 10 sec. max.
- Reflow temperature profile as below: (lead-free solder)



- When soldering, don't put stress on the LEDs
- After LEDs have been soldered, strongly recommend not to repair to keep the LEDs performance.

■ Static Electricity

- LED package is extremely sensitive to static electricity. It's recommended that anti-electrostatic glove and wrist band is necessary when handling the LEDs. All devices are also be grounded properly as well.
- Protection devices design should be considered in the LED driving circuit.

■ Cleaning

- If washing is required, recommend to use alcohol as a solvent.
- Recommend to avoid cleaning the LEDs by ultrasonic. If necessary, pre-test the LED is necessary to confirm whether any damage occur after the process.

Revision History

PC20N04 V0
Product Specification

| Date | Contents | Writer | Approved |
|------------|---------------------------|---------------|-----------|
| 2015.09.01 | Preliminary version | Jackyie Huang | John Kuo |
| 2017.09.06 | Revised edition | SK Chen | Sean Tsai |
| 2017.09.20 | Revise the outline of PKG | SK Chen | Sean Tsai |
| 2017.12.11 | Add Corrosion test items | SK Chen | Sean Tsai |

Smart Lighting Amazing Life

Lextar Electronics Corp. is the leading LED (Light Emitting Diode) maker integrating upper stream epitaxial, middle stream chip, and downstream package, SMT and LED lighting applications. Founded in May, 2008, Lextar is a subsidiary of AU Optronics, the leading TFT-LCD and solar PV manufacturer. Lextar's product applications include lighting and LCD backlight. Lextar's manufacturing sites include Hsinchu and Chunan in Taiwan, and Suzhou in China. The company turnover in 2010 is 266 million USD.